

**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN  
APPLICATION DATA SHEET (37 CFR 1.76)**

Electronic Version v11

Stylesheet Version v10

<b>Title of Invention</b>	<b>TILE-BASED ROUTING METHOD OF A MULTI-LAYER CIRCUIT BOARD AND RELATED STRUCTURE</b>
<p>As the below named inventors, we declare that:</p> <p>This declaration is directed to the invention titled: "TILE-BASED ROUTING METHOD OF A MULTI-LAYER CIRCUIT BOARD AND RELATED STRUCTURE"</p> <p>We believe that we are the original and first inventors of the subject matter which is claimed and for which a patent is sought;</p> <p>We have reviewed and understand the contents of the above-identified application, including the claims, as amended by any amendment specifically referred to above;</p> <p>We acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to us to be material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT International filing date of the continuation-in-part application.</p> <p>All statements made herein of own knowledge are true, all statements made herein on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001, and may jeopardize the validity of the application or any patent issuing thereon.</p>	
<b>FULL NAME OF INVENTORS:</b>	
Inventor 1: Chung-Yi Fang	Inventor
Signature:	Citizen of: TW
Inventor 2: Tze-Hsiang Chao	Inventor
Signature:	Citizen of: TW
Inventor 3: Yi-Show Su	Inventor

Signature:

Citizen of: TW

## Docket No SISP0002USA

I believe I am the sole (if only one name appears below), or joint (if more than one name appears), original and first inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

# "TILE-BASED ROUTING METHOD OF A MULTI-LAYER CIRCUIT BOARD AND RELATED STRUCTURE"

+ The specification for the above entitled invention is filed herewith.  
 \_\_\_\_\_ The specification for the above entitled invention was filed previously  
 with application serial number: \_\_\_\_\_ Filing Date: \_\_\_\_\_

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of the invention disclosed in this application in accordance with Title 37, Code of Federal Regulations, Section 1.56 (a). I further acknowledge the duty in any continuation-in-part application to disclose to the Patent and Trademark Office all information known to be material to the patentability of the invention disclosed in this application, as defined in 1.56, which became available to me between the filing date of the prior application and the filing date of this application.

PRIORITY CLAIM

\_\_\_\_\_ There is no claim of priority  
\_\_\_\_\_ Claim of priority is based on the following:  
\_\_\_\_\_

POWER OF ATTORNEY

As a named inventor, I hereby appoint the following attorneys to prosecute this application and to transact all related business in the Patent and Trademark Office:

Winston Hsu	Registration# 41,526	WinstonHsu@naipo.com.tw
Mord Michael Lewis	Registration# 50,478	MikeLewis@naipo.com.tw

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## DECLARATION

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued hereon.

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## POWER OF ATTORNEY OR AUTHORIZATION OF AGENT

Electronic Version v05

Stylesheet Version v05.0

Title of Invention	TILE-BASED ROUTING METHOD OF A MULTI-LAYER CIRCUIT BOARD AND RELATED STRUCTURE								
First Named Applicant: Chung- Attorney Docket Number: SISP0002USA									
<p>We hereby appoint the registered practitioner(s) at Customer Number:</p> <p>027765      </p> <p>as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.</p> <p>We are the Applicants/Inventors.</p> <p>Full Names of Applicants of Record:</p> <table border="1"><tr><td colspan="2">Winston Hsu</td></tr><tr><td>Signature: Winston Hsu</td><td>Date: 2003-06-24</td></tr><tr><td colspan="2">Mord Michael Lewis</td></tr><tr><td>Signature: Mord Michael Lewis</td><td>Date: 2003-06-24</td></tr></table>		Winston Hsu		Signature: Winston Hsu	Date: 2003-06-24	Mord Michael Lewis		Signature: Mord Michael Lewis	Date: 2003-06-24
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